Project presentation

Marcel Konieczny

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Project assumptions

Main project assumptions

- Microprocessor system
- Gas sensor TGS8100
- LCD Display

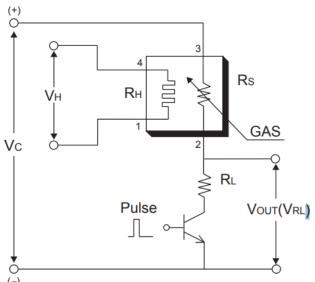


Gas sensor TGS8100

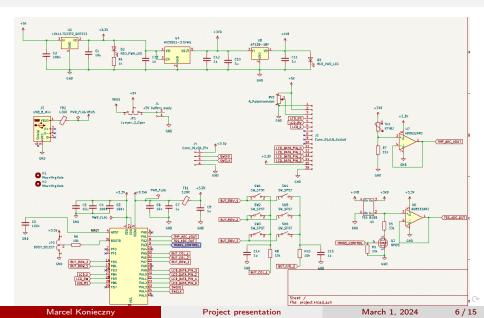
Sensor characteristics

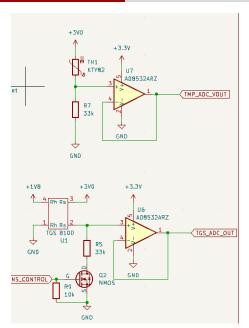
- Low power consumption (heater power consumption 15mW)
- Long life
- Highly sensitivity to cigarette smoko, cooking odors and gaseous air contaminants
- Applications: air cleaners, air quality monitors, ventilation control

How it works?

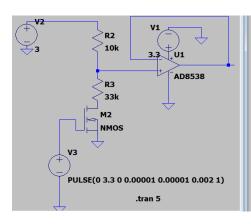


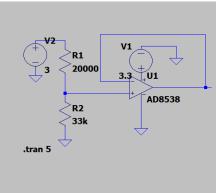
Schematic





LTSpice simulations

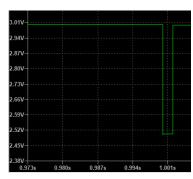




TGS8100 simulations

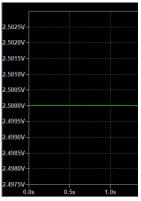


 $R = 10k\Omega$



 $R = 300k\Omega$

Temperature sensor simulations

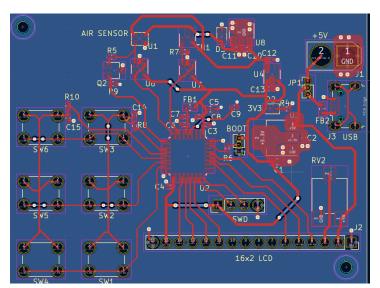


 $R = 2k\Omega (25 °C)$



$$R = 1922\Omega \ (20 \ ^{\circ}C)$$

PCB



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Measurements

The following measurements are done:

- Internal VRef channel measurement to calculate ADC VRef
- Temperature measurements
- Voltage measurement (without tgs8100 sensor)

temp_sensor	TEMP_SENSOR	{}
(x)= adc_channel	uint16_t	1
(x)= raw_val	uint16_t	3143
(x)= updated	uint8_t	1 '\001'
(x)= temp	double	22.517666539559158

Problems

During measurements the following problems were discovered

- Wrong footprints of elements
- Wrongly selected temperature sensor (measure range -55 to 150)

Conclusions

- Temperature sensor is measuring quite correctly
- Pay attention to simulations
- Pay attention to properly choose footprints



Thank you for attention